

Stenciling Procedure for Component Parts/Assemblies ES 7.3-14 Appendix 2

Each print, after a release date of March 1, 2007, will reflect a code that will inform the machine shop where and how to stencil/identify a component part/assembly. Listed below are the codes and definition of each code to be added to each print. Refer to QI-7.5.3-04 Instructions for Maintaining Traceability for stamping requirements.

<u>Code</u>	<u>Definition</u>	<u>Where Used</u>
S1	$\frac{1}{8}$ Steel Stamp / Engraving	Most commonly used on Components
S2	$\frac{1}{4}$ Low Stress Dot / Engraving	Solid Parts, Thick walled
E1	Etch	Thin walled components
T1	Tag or Bag	Components too small to etch
P1	Paint Pen	Parts that can't be stamped, etched, tagged or bagged

